

Patent

Customer No.: 31561
Docket No. 09249-US-PA
Application No.: 10/604,791

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

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In re application of

Applicant : Lee et al.

Application No. : 10/604,791

Filed : 2003/8/18

For : SEMICONDUCTOR PACKAGE MODULE AND
MANUFACTURING METHOD THEREOF

Art Unit : 2811

Examiner : NGUYEN, CUONG QUANG

TRANSMITTAL LETTER

002-1-703-872-9306

(Via fax: 8 pages)

Assistant Commissioner for Patents
Arlington, Virginia 22202

Dear Sir,

In response to the Office Action dated September 2, 2004, please find the
Response to Restriction Requirement, in 7 pages, in response to paper No.
083104.

Please charge one-month extension Fee of US\$110.00 to account No. 50-2620
(Order No.: 9249-US-PA).

If the payment is not fully covered in response thereof, the Commissioner is
authorized to charge any fees required in connection with the filing of this paper to
account No.: 50-2620 (Order No.: 9249-US-PA).

Thank you for your assistance in the subject matter. If you have any
questions, please feel free to contact me.

Respectfully Submitted,
JIANQ CHYUN Intellectual Property Office

Date: Oct. 11, 2004

By:

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